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Ultra-Low 0.35 Ω Dual SPDT Analog Switch

The NLAS5223C is an advanced CMOS analog switch fabricated in Sub-micron silicon gate CMOS technology. The device is a dual Independent Single Pole Double Throw (SPDT) switch featuring Ultra-Low R_{ON} of 0.35 Ω , at V_{CC} = 4.3 V.

The part also features guaranteed Break Before Make (BBM) switching, assuring the switches never short the driver.

Features

- Ultra–Low R_{ON}, 0.35 Ω (typ) at V_{CC} = 4.3 V
- NLAS5223C Interfaces with 2.8 V Chipset
- NLAS5223CL Interfaces with 1.8 V Chipset
- Single Supply Operation from 1.65–4.5 V
- Full 0–V_{CC} Signal Handling Capability
- High Off-Channel Isolation
- Low Standby Current, < 50 nA
- Low Distortion
- R_{ON} Flatness of 0.15 Ω
- High Continuous Current Capability
 ±320 mA Through Each Switch
- Large Current Clamping Diodes at Analog Inputs
 - ◆ ±100 mA Continuous Current Capability
- Package:
 - 1.4 x 1.8 x 0.55 mm UQFN10 Pb–Free
- These are Pb–Free Devices

Applications

- Cell Phone Audio Block
- Speaker and Earphone Switching
- Ring-Tone Chip/Amplifier Switching
- Modems



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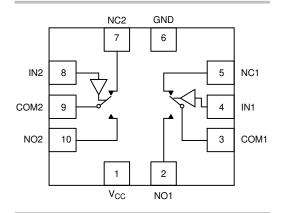
www.onsemi.com

MARKING DIAGRAM





(Note: Microdot may be in either location)



FUNCTION TABLE

| IN 1, 2 | NO 1, 2 | NC 1, 2 |
|---------|---------|---------|
| 0 | OFF | ON |
| 1 | ON | OFF |

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 9 of this data sheet.

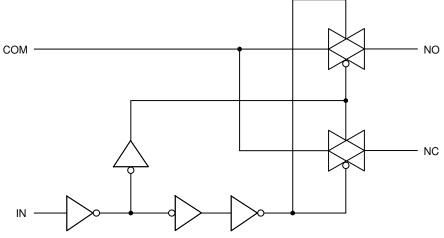


Figure 1. Logic Equivalent Circuit

PIN DESCRIPTION

| QFN PIN # | Symbol | Name and Function |
|-------------|------------------------|-------------------------|
| 2, 5, 7, 10 | NC1 to NC2, NO1 to NO2 | Independent Channels |
| 4, 8 | IN1 and IN2 | Controls |
| 3, 9 | COM1 and COM2 | Common Channels |
| 6 | GND | Ground (V) |
| 1 | V _{CC} | Positive Supply Voltage |

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|----------------------|---|--------------------------------------|------|
| V _{CC} | Positive DC Supply Voltage | -0.5 to +7.0 | V |
| V _{IS} | Analog Input Voltage (V _{NO} , V _{NC} , or V _{COM}) | $-0.5 \leq V_{IS} \leq V_{CC} + 0.5$ | V |
| V _{IN} | Digital Select Input Voltage | $-0.5 \le V_{IN} \le +5.5$ | V |
| I _{anl1} | Continuous DC Current from COM to NC/NO | ±320 | mA |
| I _{anl-pk1} | Peak Current from COM to NC/NO, 10% Duty Cycle, 100 ms = t_{ON} (Note 1) | ±600 | mA |
| I _{anl-pk2} | Instantaneous Peak Current from COM to NC/NO, 10% Duty Cycle, t_{ON} < 1 μs | ±850 | mA |
| I _{cImp} | Continuous DC Current into COM/NO/NC with Respect to $V_{\mbox{CC}}$ or GND | ±100 | mA |
| ESD | ESD Withstand Voltage Human Body Model (HBM) | >3000 | V |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Defined as 10% ON, 90% OFF Duty Cycle.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Мах | Unit |
|---------------------------------|---|------|-----------------|------|
| V _{CC} | DC Supply Voltage | 1.65 | 4.5 | V |
| V _{IN} | Digital Select Input Voltage (OVT) Overvoltage Tolerance | GND | 4.5 | V |
| V _{IS} | Analog Input Voltage (NC, NO, COM) | GND | V _{CC} | V |
| T _A | Operating Temperature Range | -40 | +85 | °C |
| t _r , t _f | Input Rise or Fall Time, SELECT $V_{CC} = 1.6 V - 2.7 V$ $V_{CC} = 3.0 V - 4.5 V$ | | 20 10 | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

| | | | | Guai | anteed Limit | |
|------------------|--|--|-----------------|------------|----------------|------|
| Symbol | Parameter | Condition | V _{CC} | 25°C | –40°C to +85°C | Unit |
| V _{IH} | Minimum High-Level Input Voltage, Select Inputs | | 3.0 4.3 | 1.4 2.0 | 1.4 2.0 | V |
| V _{IL} | Maximum Low-Level Input Voltage, Select Inputs | | 3.0 4.3 | 0.7 0.8 | 0.7 0.8 | V |
| I _{IN} | Maximum Input Leakage Current, Select Inputs | $V_{IN} = V_{CC}$ or GND | 4.3 | ±0.1 | ±1.0 | μA |
| I _{OFF} | Power Off Leakage Current | V _{IN} = V _{CC} or GND | 0 | ±0.5 | ±2.0 | μA |
| I _{CC} | Maximum Quiescent Supply Current (Note 2) | Select and $V_{IS} = V_{CC}$ or GND | 1.65 to 4.5 | ±1.0 | ±2.0 | μA |

NLAS5223C DC CHARACTERISTICS – DIGITAL SECTION (Voltages Referenced to GND)

2. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

NLAS5223C DC ELECTRICAL CHARACTERISTICS - ANALOG SECTION

| | | | | Gua | ranteed | Maximur | n Limit | |
|--|---|--|-----------------|------|--------------|---------|--------------|------|
| | | | | 25 | j°C | –40°C t | o +85°C | |
| Symbol | Parameter | Condition | V _{CC} | Min | Max | Min | Max | Unit |
| R _{ON} | NC/NO On–Resistance (Note 3) | $\label{eq:VIN} \begin{array}{l} V_{IN} = V_{IL} \mbox{ or } V_{IN} = V_{IH} \\ V_{IS} = GND \mbox{ to } V_{CC} \\ I_{COM} = 100 \mbox{ mA} \end{array}$ | 3.0 4.3 | | 0.4 0.35 | | 0.5 0.4 | Ω |
| R _{FLAT} | NC/NO On–Resistance Flatness (Notes 3 and 4) | $I_{COM} = 100 \text{ mA}$ $V_{IS} = 0 \text{ to } V_{CC}$ | 3.0 4.3 | | 0.16 0.11 | | 0.20 0.14 | Ω |
| ∆R _{ON} | On-Resistance Match Between Channels (Notes 3 and 5) | | 3.0 4.3 | | 0.05 0.05 | | 0.05 0.05 | Ω |
| I _{NC(OFF)} I _{NO(OFF)} | NC or NO Off Leakage Current (Note 3) | $ \begin{array}{l} V_{IN} = V_{IL} \text{ or } V_{IH} \\ V_{NO} \text{ or } V_{NC} = 0.3 \text{ V} \\ V_{COM} = \ 4.0 \text{ V} \end{array} $ | 4.3 | -5.0 | 5.0 | -50 | 50 | nA |
| I _{COM(ON)} | COM ON Leakage Current (Note 3) | $\label{eq:VIN} \begin{array}{l} V_{IN} = V_{IL} \mbox{ or } V_{IH} \\ V_{NO} \mbox{ 0.3 V or } 4.0 \mbox{ V with} \\ V_{NC} \mbox{ floating or } \\ V_{NO} \mbox{ 0.3 V or } 4.0 \mbox{ V with} \\ V_{NO} \mbox{ floating } \\ V_{COM} = 0.3 \mbox{ V or } 4.0 \mbox{ V} \end{array}$ | 4.3 | -10 | 10 | -100 | 100 | nA |

3. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

4. Flatness is defined as the difference between the maximum and minimum value of On-resistance as measured over the specified analog signal ranges.

5. $\Delta R_{ON} = R_{ON(MAX)} - R_{ON(MIN)}$ between NC1 and NC2 or between NO1 and NO2.

NLAS5223CL DC CHARACTERISTICS – DIGITAL SECTION (Voltages Referenced to GND)

| | | | | Guaranteed Limit | | |
|------------------|--|--|-----------------|------------------|----------------|------|
| Symbol | Parameter | Condition | V _{CC} | 25°C | –40°C to +85°C | Unit |
| V _{IH} | Minimum High-Level Input Voltage, Select Inputs | | 3.0 4.3 | 1.3 1.6 | 1.3 1.6 | V |
| V _{IL} | Maximum Low–Level Input Voltage, Select Inputs | | 3.0 4.3 | 0.5 0.6 | 0.5 0.6 | V |
| I _{IN} | Maximum Input Leakage Current, Select Inputs | V _{IN} = 4.5 V or GND | 4.3 | ±0.1 | ±1.0 | μΑ |
| I _{OFF} | Power Off Leakage Current | V _{IN} = 4.5 V or GND | 0 | ±0.5 | ±2.0 | μA |
| I _{CC} | Maximum Quiescent Supply Current | Select and $V_{IS} = V_{CC}$ or GND | 1.65 to 4.5 | ±1.0 | ±2.0 | μA |
| ICCV | Maximum Quiescent Supply Current, Low Voltage Driving (Note 6) | $V_{IS} = V_{CC} \text{ or } GND$ $V_{IN} = 1.65 \text{ V}$ | 4.3 | ±145 | ±150 | μΑ |
| | | $V_{IS} = V_{CC} \text{ or } GND$ $V_{IN} = 1.80 \text{ V}$ | | ±125 | ±130 | |
| | | $V_{IS} = V_{CC}$ or GND $V_{IN} = 2.60$ V | | ±50 | ±55 | |

6. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

NLAS5223CL DC ELECTRICAL CHARACTERISTICS – ANALOG SECTION

| | | | | Gua | ranteed | Maximur | n Limit | |
|--|---|---|-----------------|-----|--------------|---------|--------------|------|
| | | | | 25 | o°C | –40°C t | o +85°C | |
| Symbol | Parameter | Condition | v _{cc} | Min | Max | Min | Max | Unit |
| R _{ON} | NC/NO On–Resistance (Note 7) | | 3.0 4.3 | | 0.4 0.35 | | 0.5 0.4 | Ω |
| R _{FLAT} | NC/NO On–Resistance Flatness (Notes 7 and 8) | $I_{COM} = 100 \text{ mA}$ $V_{IS} = 0 \text{ to } V_{CC}$ | 3.0 4.3 | | 0.16 0.11 | | 0.20 0.14 | Ω |
| ΔR _{ON} | On-Resistance Match Between Channels (Notes 7 and 9) | $V_{IS} = 1.5 V; \\ I_{COM} = 100 \text{ mA} \\ V_{IS} = 2.2 V; \\ I_{COM} = 100 \text{ mA} \end{cases}$ | 3.0 4.3 | | 0.05 0.05 | | 0.05 0.05 | Ω |
| I _{NC(OFF)} I _{NO(OFF)} | NC or NO Off Leakage Current (Note 7) | $ \begin{array}{l} V_{IN} = V_{IL} \text{ or } V_{IH} \\ V_{NO} \text{ or } V_{NC} = 0.3 \text{ V} \\ V_{COM} = \ 4.0 \text{ V} \end{array} $ | 4.3 | -10 | 10 | -100 | 100 | nA |
| I _{COM(ON)} | COM ON Leakage Current (Note 7) | $\label{eq:VIN} \begin{array}{l} V_{IN} = V_{IL} \mbox{ or } V_{IH} \\ V_{NO} \mbox{ 0.3 V or 4.0 V with} \\ V_{NC} \mbox{ floating or} \\ V_{NC} \mbox{ 0.3 V or 4.0 V with} \\ V_{NO} \mbox{ floating} \\ V_{COM} = \mbox{ 0.3 V or 4.0 V} \end{array}$ | 4.3 | -10 | 10 | -100 | 100 | nA |

7. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

8. Flatness is defined as the difference between the maximum and minimum value of On-resistance as measured over the specified analog signal ranges.

9. $\Delta R_{ON} = R_{ON(MAX)} - R_{ON(MIN)}$ between NC1 and NC2 or between NO1 and NO2.

AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0 \text{ ns}$)

| | | | | | Guaranteed Maximum Limit | | | | | |
|------------------|-----------------------------------|--|-----------------|-----|--------------------------|------|-----|----------|---------|------|
| | | | V _{cc} | VIS | | 25°C | | –40°C to | o +85°C | |
| Symbol | Parameter | Test Conditions | (V) | (V) | Min | Тур* | Max | Min | Max | Unit |
| t _{ON} | Turn–On Time | $R_L = 50 \Omega$, $C_L = 35 pF$ (Figures 3 and 4) | 2.3 – 4.5 | 1.5 | | | 50 | | 60 | ns |
| toff | Turn–Off Time | $R_L = 50 \ \Omega$, $C_L = 35 \ pF$ (Figures 3 and 4) | 2.3 – 4.5 | 1.5 | | | 30 | | 40 | ns |
| t _{BBM} | Minimum Break–Before–Make Time | | 3.0 | 1.5 | 2 | 15 | | | | ns |

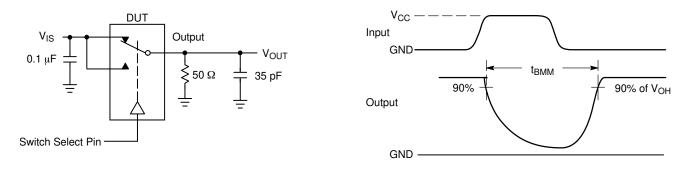
| | | Typical @ 25, V _{CC} = 3.6 V | |
|--------------------|---|---------------------------------------|----|
| C _{IN} | Control Pin Input Capacitance | 3.5 | pF |
| C _{NO/NC} | NO, NC Port Capacitance | 60 | pF |
| C _{COM} | COM Port Capacitance When Switch is Enabled | 200 | pF |

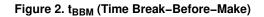
*Typical Characteristics are at 25° C.

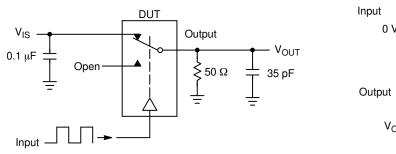
ADDITIONAL APPLICATION CHARACTERISTICS (Voltages Referenced to GND Unless Noted)

| | | | V _{CC} | 25°C | |
|------------------|--|--|-----------------|---------|------|
| Symbol | Parameter | Condition | (V) | Typical | Unit |
| BW | Maximum On–Channel –3 dB Bandwidth or Minimum Frequency Response | V _{IN} centered between V _{CC} and GND (Figure 5) | 1.65 – 4.5 | 24 | MHz |
| V _{ONL} | Maximum Feed-through On Loss | $V_{IN} = 0 \text{ dBm } @ 100 \text{ kHz}$ to 50 MHz V_{IN} centered between V_{CC} and GND (Figure 5) | 1.65 – 4.5 | -0.06 | dB |
| V _{ISO} | Off-Channel Isolation | f = 100 kHz; V_{IS} = 1 V RMS; C_L = 5.0 pF V_{IN} centered between V_{CC} and GND (Figure 5) | 1.65 – 4.5 | -68 | dB |
| Q | Charge Injection Select Input to Common I/O | $V_{IN} = V_{CC to} \text{ GND}, \text{R}_{IS} = 0 \Omega, \text{C}_{L} = 1.0 \text{nF}$ Q = C _L x DV _{OUT} (Figure 6) | 1.65 – 4.5 | 38 | рС |
| THD | Total Harmonic Distortion THD + Noise | F_{IS} = 20 Hz to 20 kHz, R_L = R_{gen} = 600 $\Omega,~C_L$ = 50 pF V_{IS} = 2.0 V RMS | 3.0 | 0.08 | % |
| VCT | Channel-to-Channel Crosstalk | f = 100 kHz; V_{IS} = 1.0 V RMS, C_L = 5.0 pF, R_L = 50 Ω V_{IN} centered between V_{CC} and GND (Figure 5) | 1.65 – 4.5 | -70 | dB |

10. Off–Channel Isolation = 20log10 (V_{COM}/V_{NO}), V_{COM} = output, V_{NO} = input to off switch.







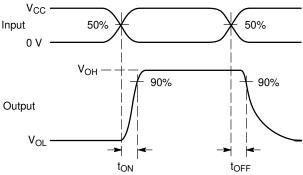
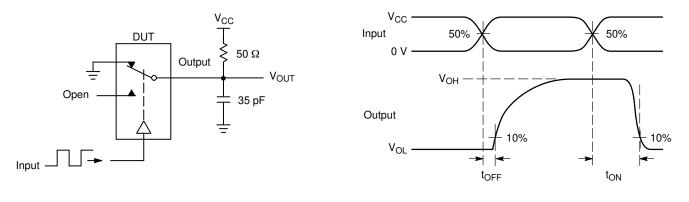
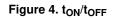
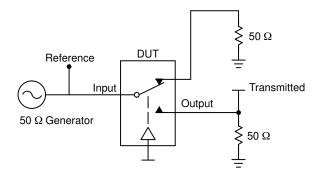


Figure 3. t_{ON}/t_{OFF}



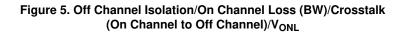




Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. V_{ISO} , Bandwidth and V_{ONL} are independent of the input signal direction.

$$\begin{split} V_{ISO} &= Off \ Channel \ Isolation = 20 \ Log\Bigl(\frac{V_{OUT}}{V_{IN}}\Bigr) for \ V_{IN} \ at \ 100 \ kHz \\ V_{ONL} &= On \ Channel \ Loss = 20 \ Log\Bigl(\frac{V_{OUT}}{V_{IN}}\Bigr) for \ V_{IN} \ at \ 100 \ kHz \ to \ 50 \ MHz \end{split}$$

Bandwidth (BW) = the frequency 3 dB below V_{ONL} V_{CT} = Use V_{ISO} setup and test to all other switch analog input/outputs terminated with 50 Ω



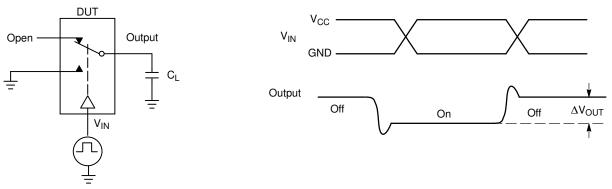
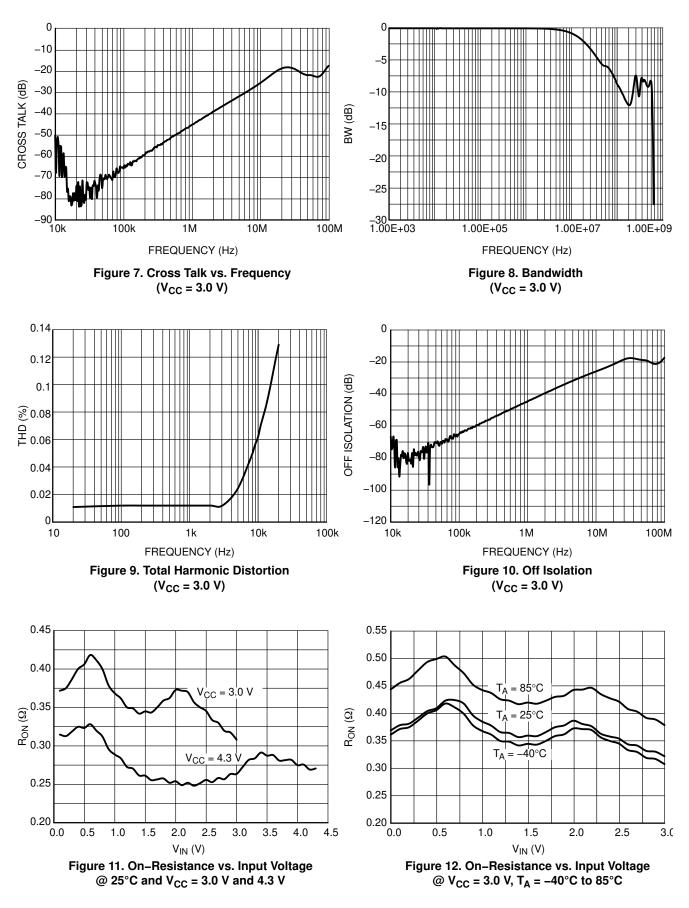
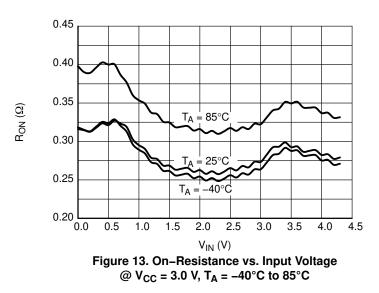


Figure 6. Charge Injection: (Q)



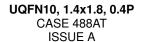


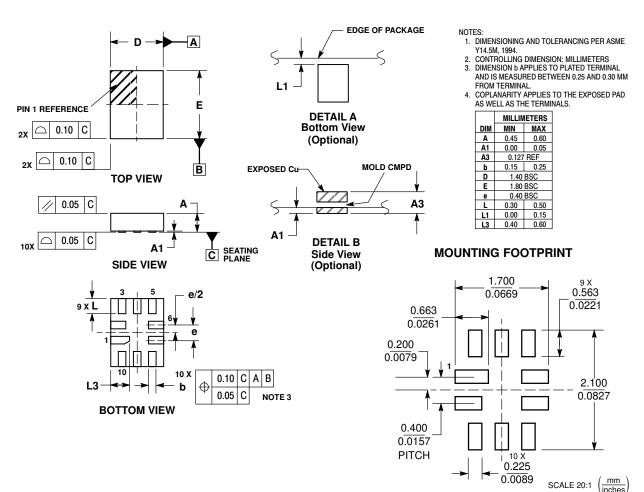
ORDERING INFORMATION

| Device | Marking | Package | Shipping [†] |
|-----------------|---------|---------------------|-----------------------|
| NLAS5223CMUTAG | AK | UQFN10 (Pb-Free) | 3000 / Tape & Reel |
| NLAS5223CLMUTAG | AU | UQFN10 (Pb-Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS





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